

Thunder High Power Products

Silicon Field Stop(FS) Trench IGBT

Description

The THG75T65FQK is use advanced field stop(FS) trench technology.

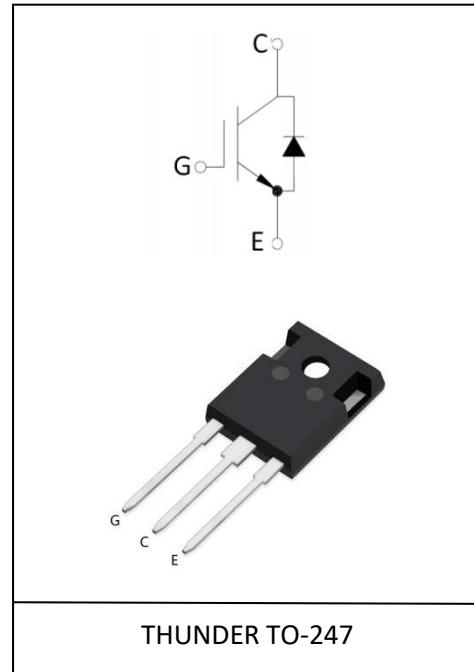
The 650V FS Trench IGBT offers superior conduction and switching performances.

General Features

- High Speed Switching & Low Power Loss
- Low saturation voltage: $V_{CE(sat)} = 1.7V @ I_c = 75A$
- Low EMI
- Maximum junction temperature 175°C

Application

- Solar Converters
- Welding Converters
- UPS
- PFC
- PV Inverter



Absolute Maximum Ratings @ $T_c=25^\circ\text{C}$ (unless otherwise specified)

Symbol	Parameter	Value	Units
V_{CES}	Collector-Emitter Voltage	650	V
V_{GES}	Gate-Emitter Voltage	± 20	V
I_c	Collector Current	150	A
	Collector Current @ $T_c=100^\circ\text{C}$	75	A
I_{CM}	Pulsed Collector Current	300	A
I_F	Diode Continuous Forward Current @ $T_c=100^\circ\text{C}$	75	A
I_{FM}	Diode Maximum Forward Current	300	A
P_D	Total Dissipation at @ $T_c = 25^\circ\text{C}$	438	W
	Total Dissipation at @ $T_c = 100^\circ\text{C}$	219	
T_j	Operating Junction and Storage Temperature Range	-55 to +175	°C
T_L	Max Temperature For Soldering	260	°C
T_{sc}	Short circuit data $V_{GE}=15V$, $V_{CC} \leq 360V$, $T_{vj}=150^\circ\text{C}$	5	us

Electrical Characteristics @ $T_c=25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Static Characteristics						
V_{CES}	Collector-Emitter Voltage	$V_{GE}=0V, I_{CE}=250\mu A$	650	—	—	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$V_{GE}=15V, T_j = 25^\circ C$ $I_C=75A$	—	1.70	2.00	V
$V_{GE(th)}$	Gated Threshold Voltage	$V_{CE}=V_{GE}, I_C=0.5mA$	4.5	5.5	6.5	V
I_{CES}	Collector-Emitter Leakage Current	$V_{GE}=0V, V_{CE}=650V$	—	—	20	μA
$I_{GES(F)}$	Gate to Emitter Forward Leakage	$V_{GE} = +20V, V_{CE} = 0V$	—	—	200	nA
$I_{GES(R)}$	Gate to Emitter Reverse Leakage	$V_{GE} = -20V, V_{CE} = 0V$	—	—	-200	nA
Dynamic Characteristics						
C_{ies}	Input Capacitance	$V_{GE}=0V, V_{CE}=25V, f=1.0MHz$	—	7350	—	pF
C_{oes}	Output Capacitance		—	277	—	pF
C_{res}	Reverse Transfer Capacitance		—	158	—	pF
Q_g	Total Gate Charge	$V_{CE}=480V, I_C=40A, V_{GE}=15V$	—	312	—	nC
Q_{ge}			—	68	—	
Q_{gc}			—	129	—	
Switching Characteristics						
$t_{d(on)}$	Turn-on Delay Time	$V_{CE}=400V, I_C=40A$ $V_{GE}=15V, R_G=10\Omega$	—	25	—	nS
t_r	Rise Time		—	21	—	
$t_{d(off)}$	Turn-off Delay Time		—	170	—	
t_f	Fall Time		—	22	—	

Electrical Characteristics of the Diode @ $T_c = 25^\circ C$ unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
I_F	Diode Continuous Forward Current	$T_c = 100^\circ C$	75	—	—	A
I_{FM}	Diode Maximum Forward Current	$T_c = 100^\circ C$	300	—	—	A
V_F	Diode Forward Voltage	$I_F = 75A$	—	1.75	2.15	V
t_{rr}	Reverse Recovery Time	$T_j=25^\circ C, I_F=40A$ $di/dt=200A/us$	—	280	—	ns
Q_{rr}	Reverse Recovery Charge		—	9.1	—	nC

*Pulse Test: Pulse Width <= 300μs, Duty Cycle< =2%

Thermal Characteristic

Symbol	Paramter	Typ	MAX	Units
$R_{\theta JC}$	Themal Resistance,Junction to case for IGBT	--	0.36	°C/W
$R_{\theta JC}$	Themal Resistance,Junction to case for Diode	--	0.48	°C/W
$R_{\theta JA}$	Themal Resistance,Junction to Ambient	--	40	°C/W

Typical Performance Characteristics

Figure 1 Output Characteristics

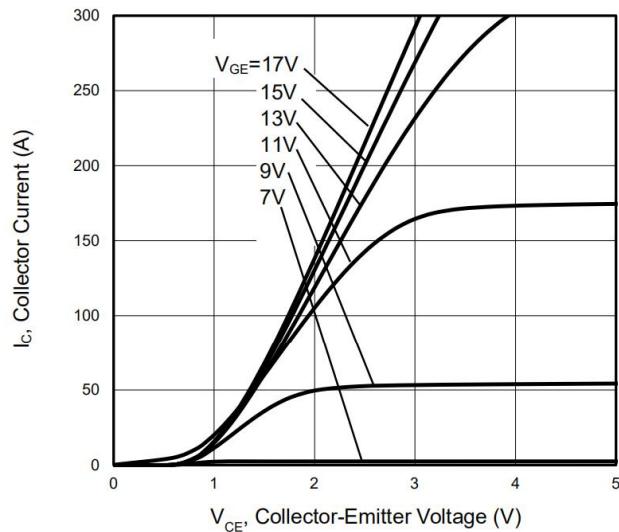


Figure 2 Transfer Characteristics

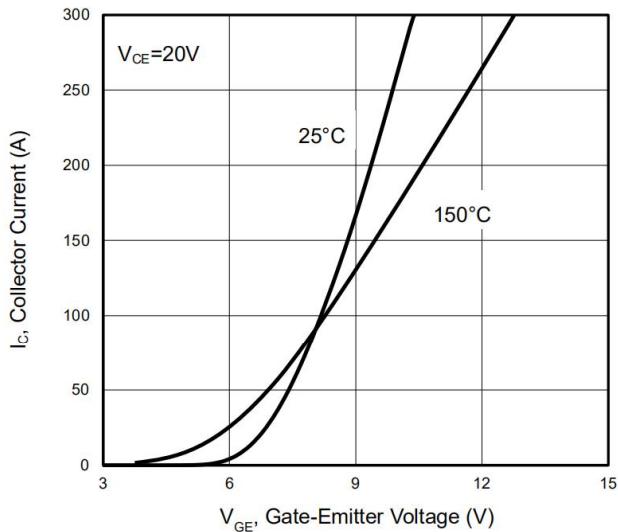


Figure 3 $V_{CE(sat)}$ vs. Temperature

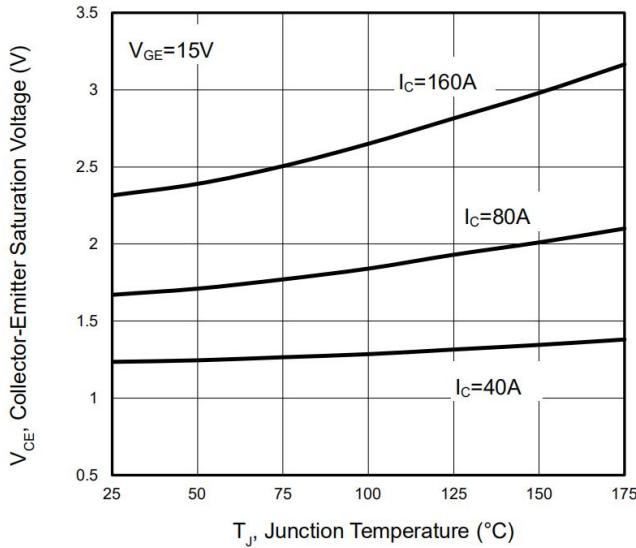


Figure 4 Saturation Voltage vs. V_{GE}

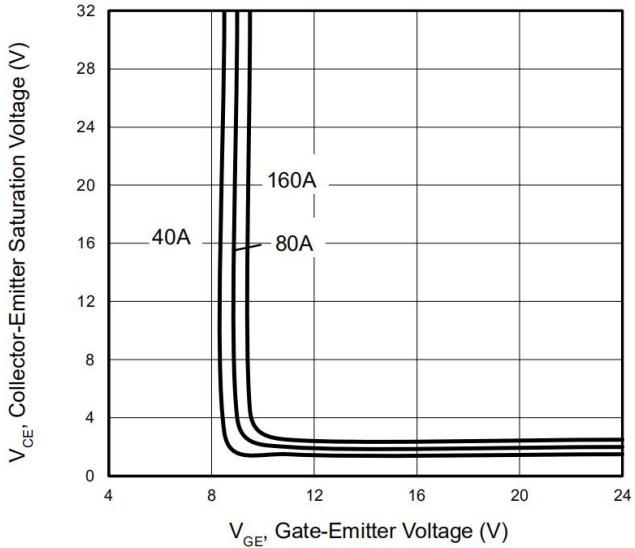


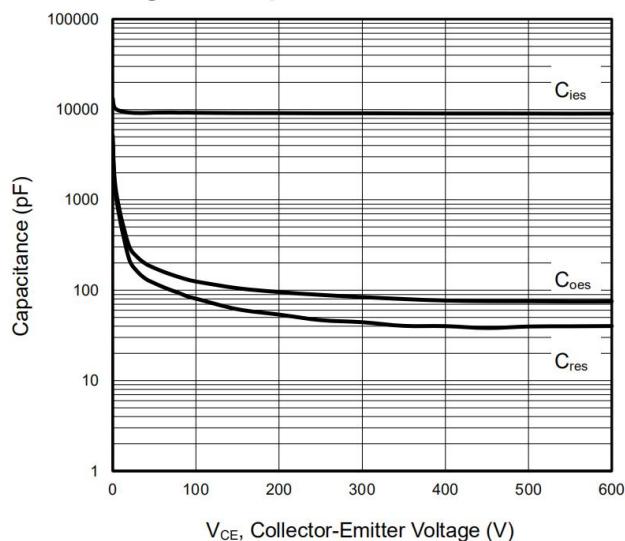
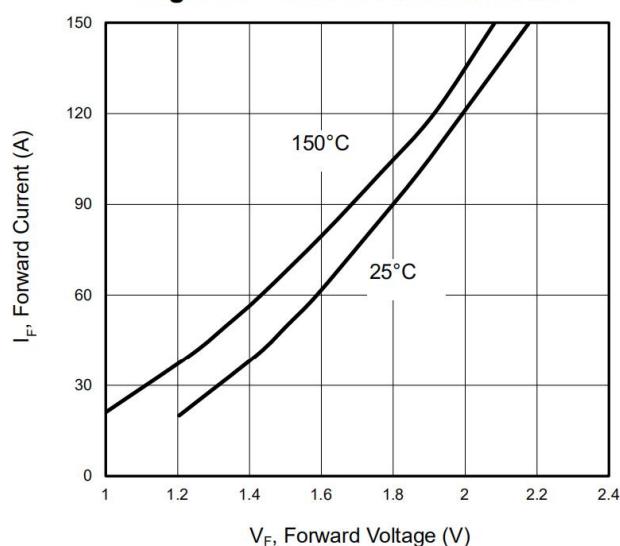
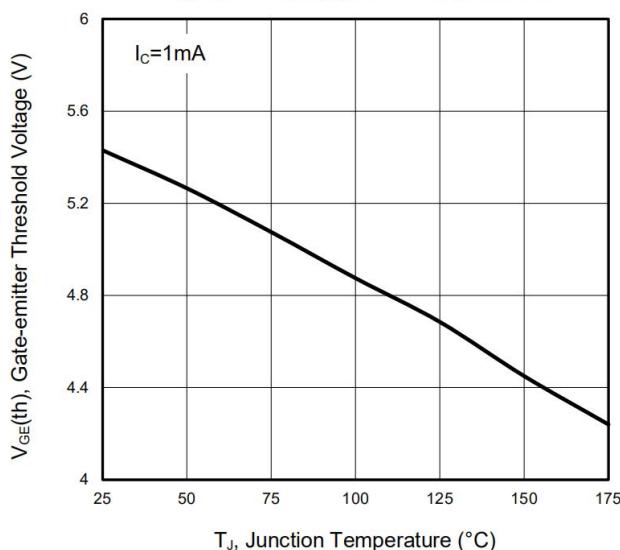
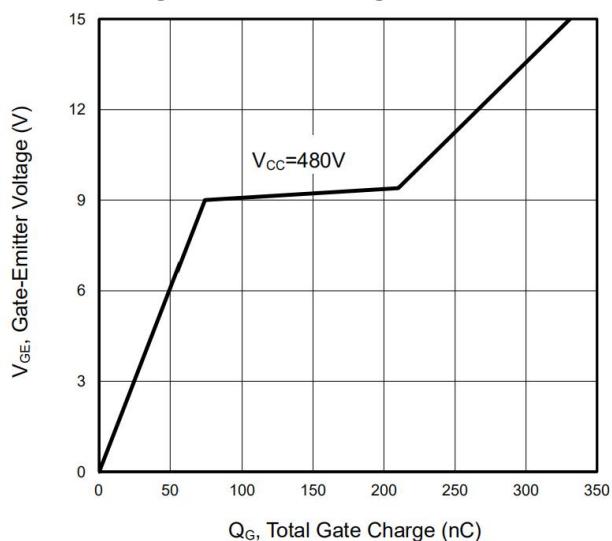
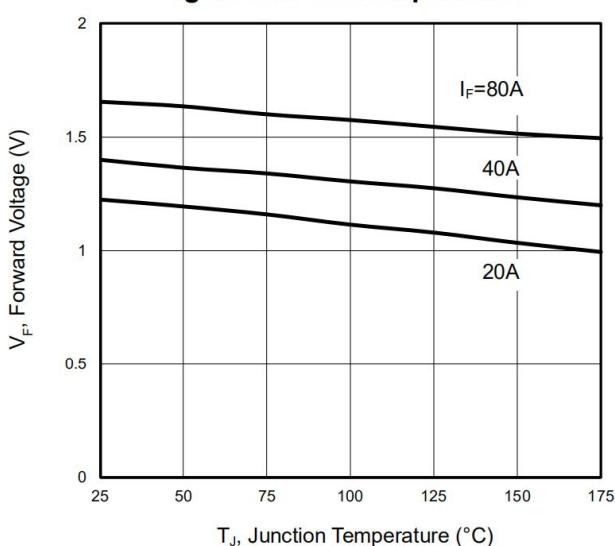
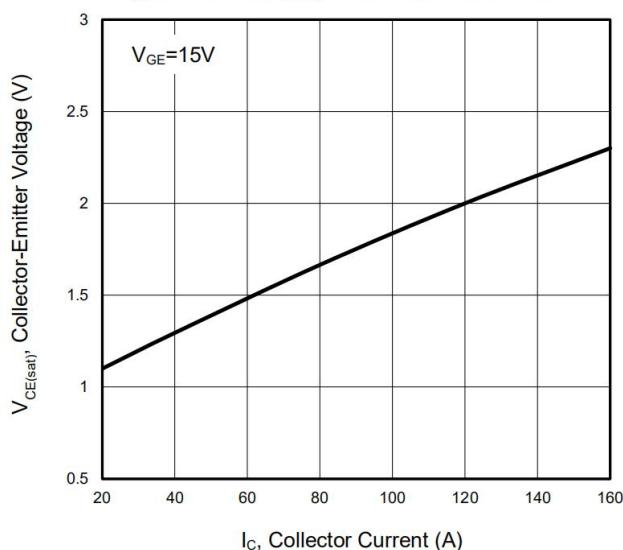
Figure 5 Capacitance Characteristics

Figure 7 Forward Characteristics

Figure 9 $V_{GE(th)}$ vs. Temperature

Figure 6 Gate Charge Wave Form

Figure 8 V_F vs. Temperature

Figure 10 $V_{CE(sat)}$ vs. Collector Current


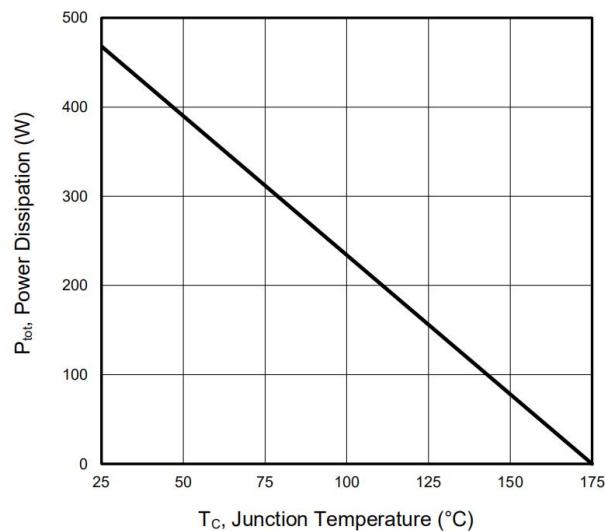
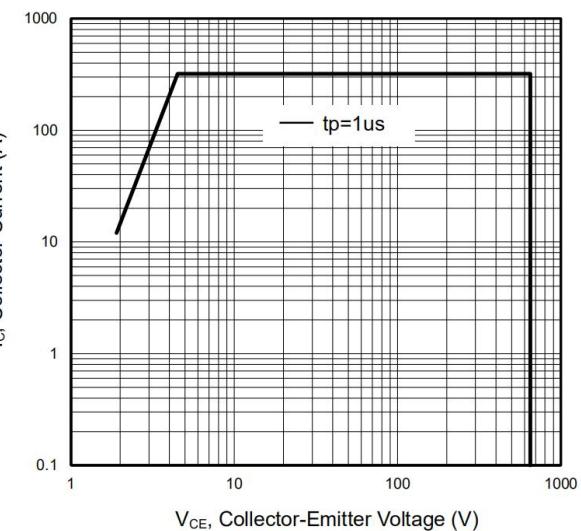
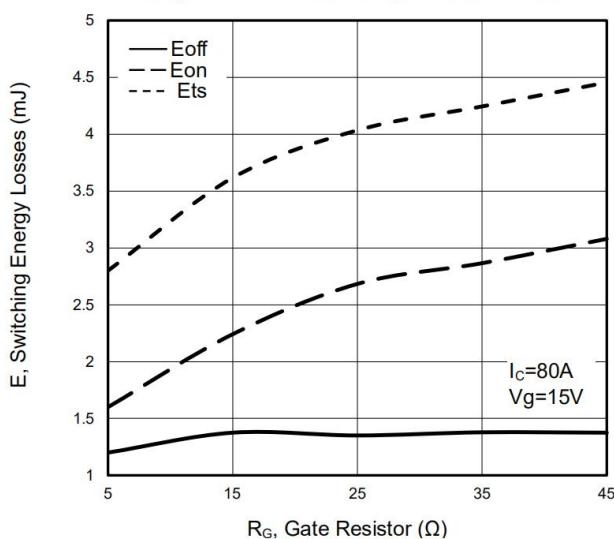
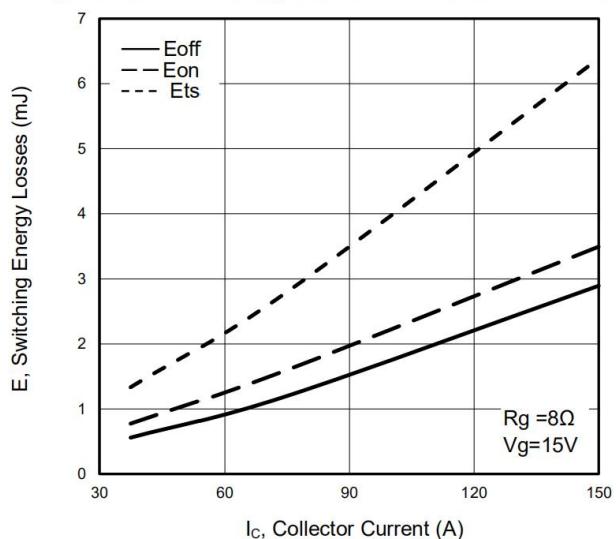
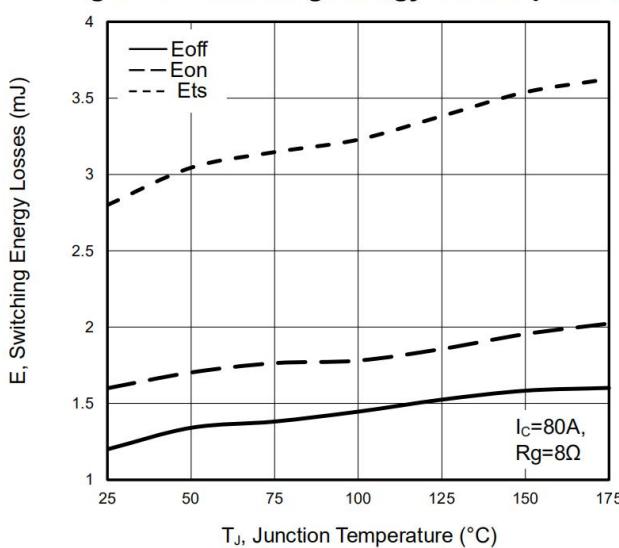
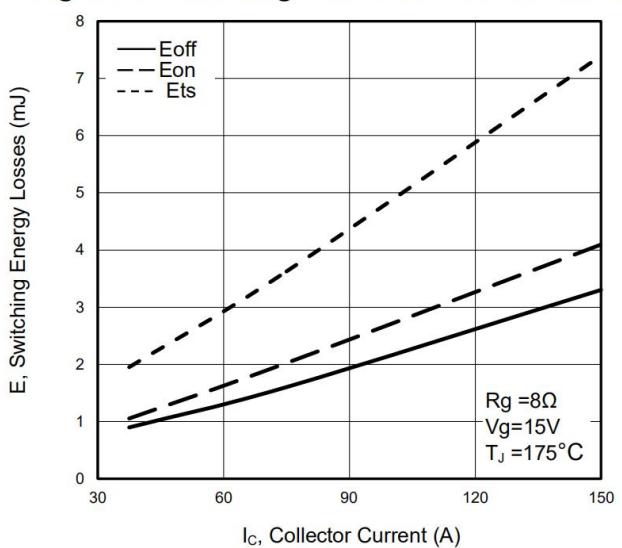
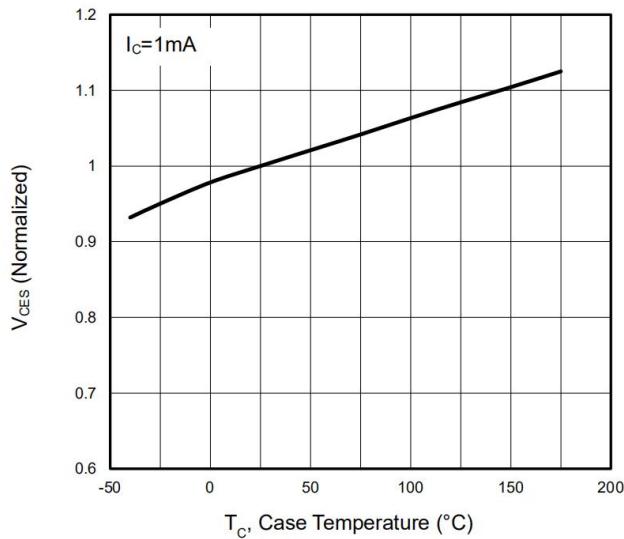
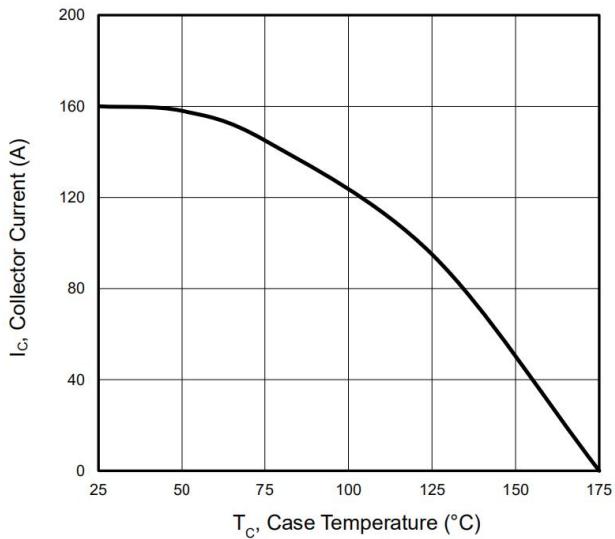
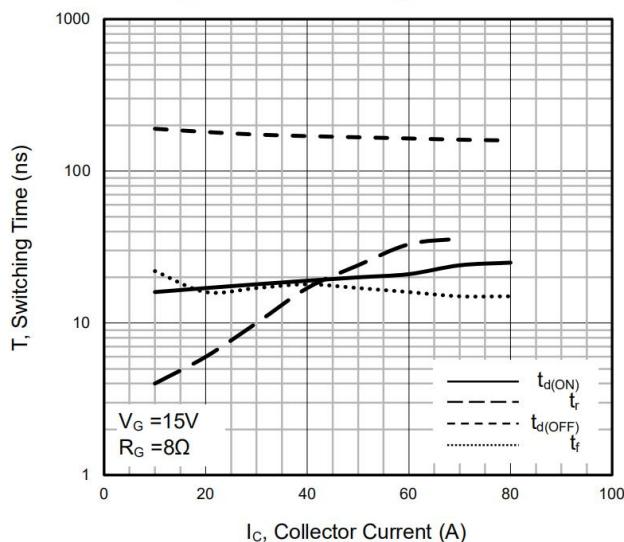
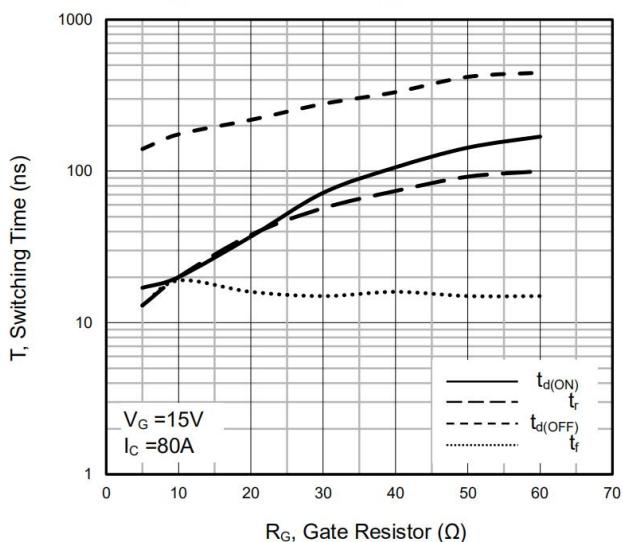
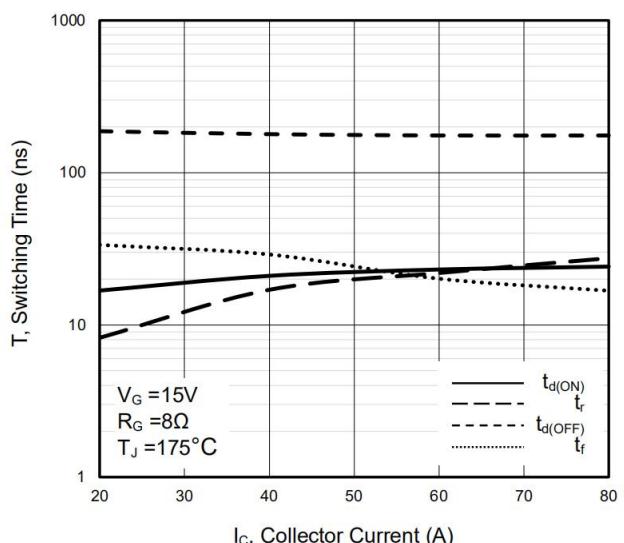
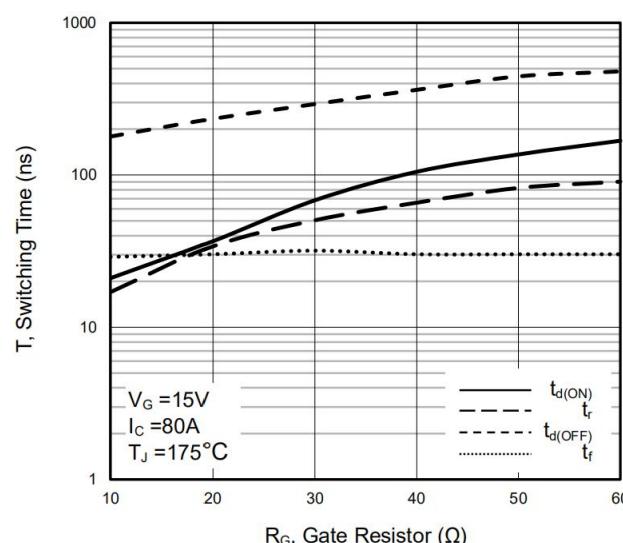
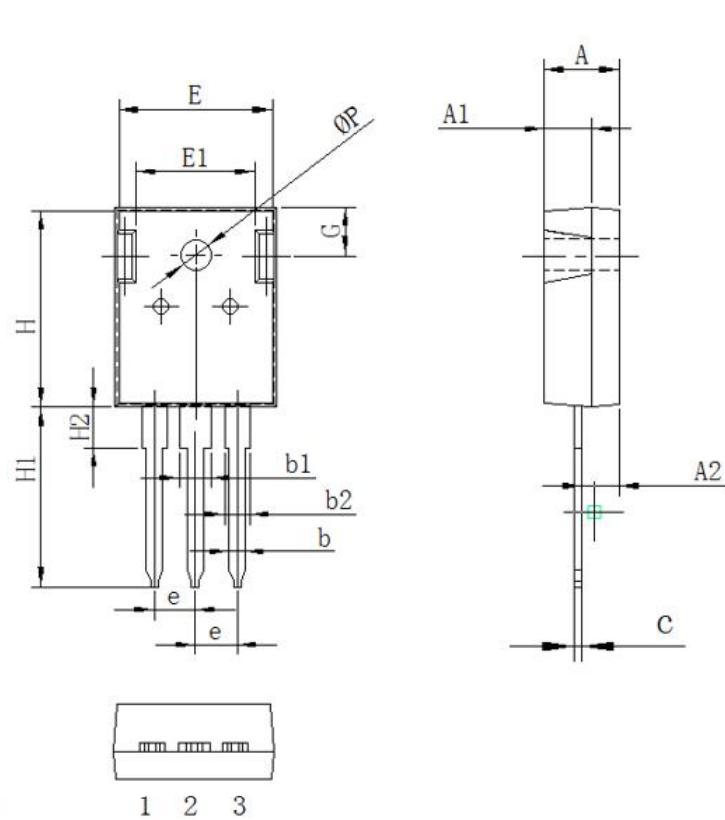
Figure 11 P_{tot} vs. Case Temperature

Figure 12 Forward Bias Safe Operating Area

Figure 13 Switching Loss vs. R_G

Figure 14 Switching Loss vs. Collector Current

Figure 15 Switching Energy vs. Temperature

Figure 16 Switching Loss vs. Collector Current


Figure 17 V_{CES} vs. Case Temperature

Figure 18 I_C vs. Temperature

Figure 19 Switching Time vs. I_C

Figure 20 Switching Time vs. R_G

Figure 21 Switching Time vs. I_C

Figure 22 Switching Time vs. R_G


Package Information

TO-247 PACKAGE



基本尺寸

Symbol	单位 mm		
	Min	Nom	Max
A	4.8	5.00	5.20
A1	3.3	3.5	3.7
A2	2.20	2.40	2.60
b	1.00	1.2	1.40
b1	2.90	3.10	3.30
b2	1.90	2.10	2.30
c	0.50	0.60	0.70
e	5.25	5.45	5.65
E	15.2	15.7	16.2
E1	10.2	10.7	11.2
H	20.8	21	21.2
H1	19.5	20.0	20.5
H2	4.00	4.20	4.40
G	5.60	5.80	600
ΦP	3.50	3.70	3.90

Notice

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-Headquarters

WuXi Thunder Microelectronics Incorporated Limited

Building E1-9L, No.200 LingHu Road, XinWu district, WuXi, China 214135

Tel:+86-510-85160109 Fax:+86-510-85160109